

Vishay Siliconix

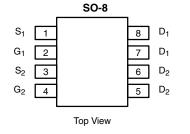
RoHS

COMPLIANT HALOGEN

FREE

Dual N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
30	0.0195 at V _{GS} = 10 V	8.5	7.1		
30	0.023 at V _{GS} = 4.5 V	8.6	7.1		



Ordering Information:

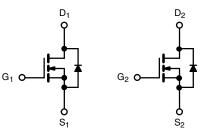
Si4214DDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Notebook System Power
- Low Current DC/DC



N-Channel MOSFET

N-Channel N	NOSF
	1001

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	30	v		
Gate-Source Voltage	V _{GS}	± 20	v		
	T _C = 25 °C		8.5		
Continuous Drain Current (T 150 °C)	T _C = 70 °C	L.	7.5		
Continuous Drain Current ($T_J = 150 \text{ °C}$)	T _A = 25 °C	I _D	7.5 ^{b, c}		
	T _A = 70 °C		5.9 ^{b, c}		
Pulsed Drain Current		I _{DM}	30	А	
Source-Drain Current Diode Current	T _C = 25 °C	I _S	2.8		
Source-Drain Current Diode Current	T _A = 25 °C	'S	1.8 ^{b, c}		
Pulsed Source-Drain Current		I _{SM}	30		
Single Pulse Avalanche Current L = 0.1 mH		I _{AS}	10		
Single Pulse Avalanche Energy	L = 0.1 1111	E _{AS}	5		
	T _C = 25 °C		3.1		
Maximum Dawar Dissinction	T _C = 70 °C	PD	2	w	
Maximum Power Dissipation	T _A = 25 °C	'D	2 ^{b, c}		
	T _A = 70 °C		1.25 ^{b, c}	1	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Тур.	Max.	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	52	62.5	°C/W			
Maximum Junction-to-Foot (Drain)	Steady-State	R _{thJF}	30	40	0/11			

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 110 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•			•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	$\Delta V_{DS}/T_J$ $I_D = 250 \ \mu A$		3		m\//°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.2		mV/°C	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			100	nA	
	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_S = 30 V, V _{GS} = 0 V		1		
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10	μA	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	20			Α	
	_	V _{GS} = 10 V, I _D = 8 A		0.016	0.0195	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		0.019	0.023		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 8 A		27		S	
Dynamic ^b				I	<u>. </u>		
Input Capacitance	C _{iss}			660			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ I}_{D} = 1 \text{ MHz}$		140		pF	
Reverse Transfer Capacitance	C _{rss}			86			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	14.5	22	-		
				7.1	11	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 8 \text{ A}$		1.9			
Gate-Drain Charge	Q _{gd}			2.7			
Gate Resistance	R _g	f = 1 MHz	0.5	2.6	5.2	Ω	
Turn-On Delay Time	t _{d(on)}			14	28	-	
Rise Time	t _r	V_{DD} = 15 V, R_L = 3 Ω		45	80		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D} \cong \text{5}$ A, V_GEN = 4.5 V, R_g = 1 Ω		18	35		
Fall Time	t _f			12	24		
Turn-On Delay Time	t _{d(on)}			7	14	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 3 Ω		10	20	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5$ A, V_{GEN} = 10 V, R_g = 1 Ω		15	30		
Fall Time	t _f			7	14		
Drain-Source Body Diode Characterist	cs	· · · · · · · · · · · · · · · · · · ·		•			
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			2.8	٨	
Pulse Diode Forward Current ^a	I _{SM}				30	A	
Body Diode Voltage	V _{SD}	I _S = 2 A		0.77	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			17	34	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			9	18	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		10	1		
Reverse Recovery Rise Time	t _b	Ē		7	1	nS	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

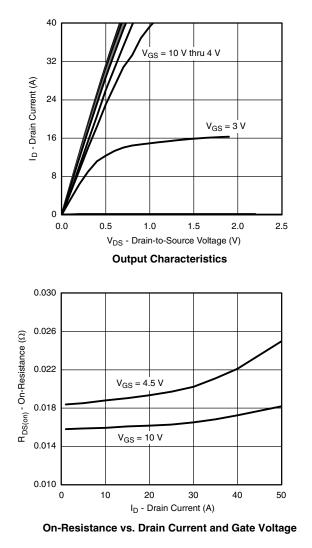
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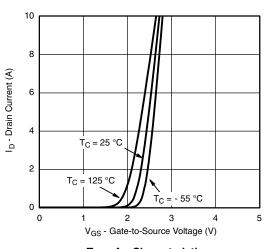


Si4214DDY Vishay Siliconix

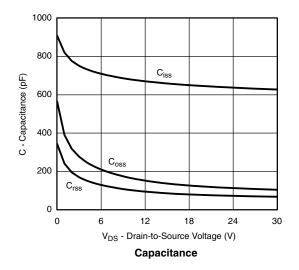
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

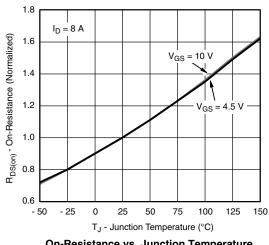


10 $I_D = 8 A$ V_{GS} - Gate-to-Source Voltage (V) 8 V_{DS} = 10 V 6 $V_{DS} = 20 V$ V_{DS} = 15 V 4 2 0 12.8 0.0 3.2 6.4 9.6 16 Qg - Total Gate Charge (nC) **Gate Charge**



Transfer Characteristics





On-Resistance vs. Junction Temperature

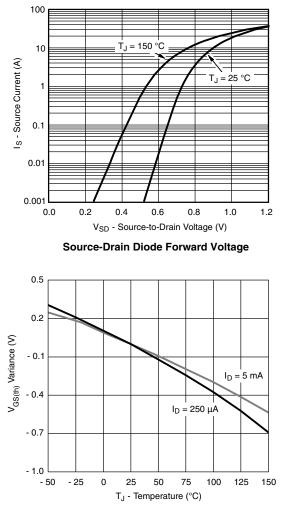
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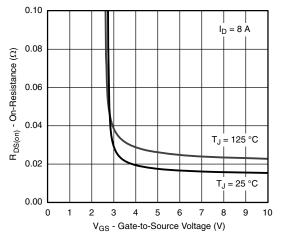
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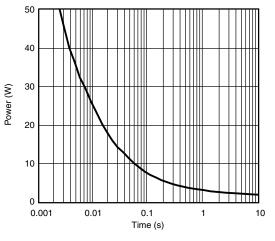
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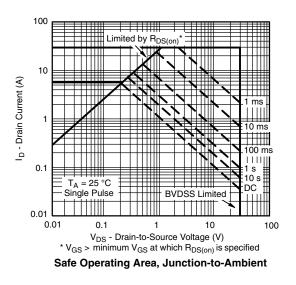
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



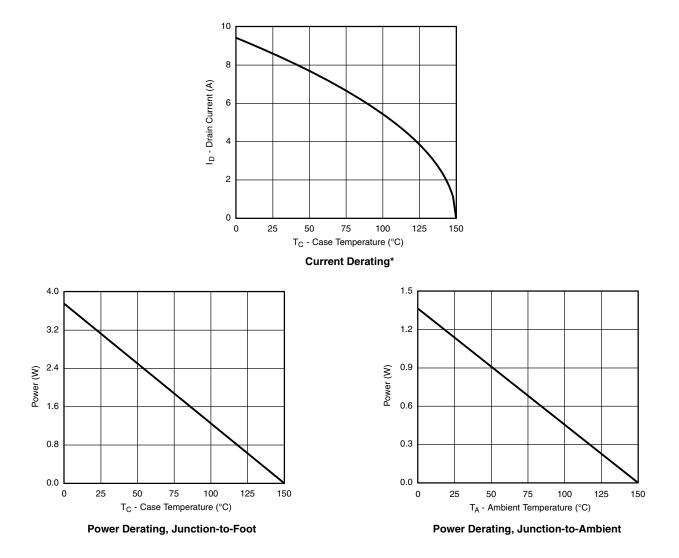
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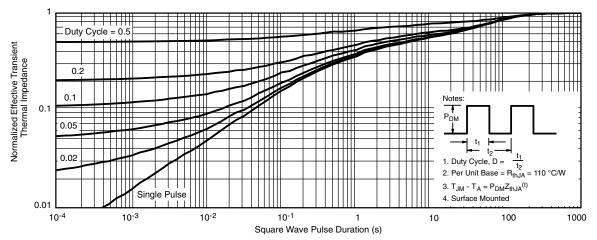


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

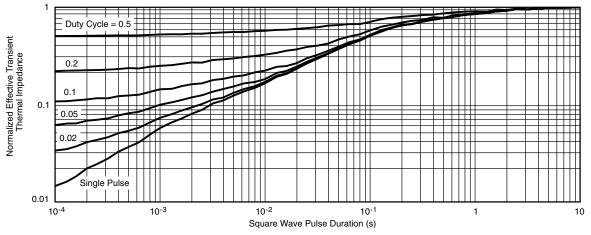


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65022.

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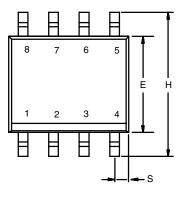


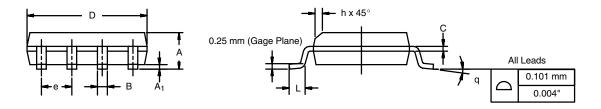
Package Information

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SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





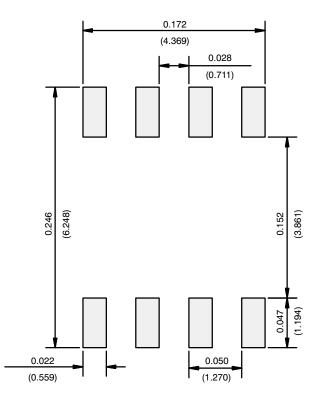
	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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